SCOPE:

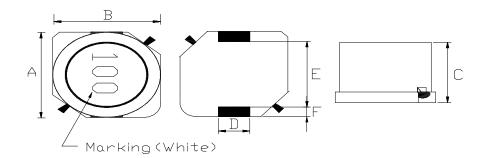
This specification applies to the Pb Free high current type SMD inductors for MSCDRI-105F-SERIES

PRODUCT INDENTIFICATION

MSCDRI-105F-100 M

- 1
- 2
- 3 4
- ① Product Code
- ② Dimensions Code
- **3 Inductance Code**
- **4** Tolerance Code

(1) SHAPES AND DIMENSIONS



A: 10.0± 0.3 mm

B: 10.0± 0.3 mm

C: 4.50± 0.3 mm

D: 3.00± 0.2 mm

E: 6.00 Typ. mm

F: 2.00 Typ. mm

(2) ELECTRICAL SPECIFICATIONS SEE TABLE 1

TEST INSTRUMENTS

L: HP 4284A PRECISION LCR METER (or equivalent)

RDC: CHROMA MODEL 16502 MILLIOHMMETER (or equivalent)

(3) CHARACTERISTICS

(3)-1 Ambient temperature +60°C Max.

(3)-2 Operate temperature range -40° C $\sim +125^{\circ}$ C

(Including self temp. rise)



TABLE 1

TABLET							
MAGLAYERS	Inductance	Percent	Test	Resistance	Rated Do	C Current	Marking
PT/NO.	L(µH)	Tolerance	Frequency	RDC(Ω)±20%	IDC1(A)	IDC2(A)	Marking
MSCDRI-105F-3R3□	3.3	N	100kHz,0.25V	16.1m	4.90	3.70	3R3
MSCDRI-105F-5R6□	5.6	N	100kHz,0.25V	22.0m	3.80	3.20	5R6
MSCDRI-105F-100□	10	M,N	100kHz,0.25V	36.4m	3.00	2.50	100
MSCDRI-105F-150□	15	M,N	100kHz,0.25V	47.2m	2.40	2.20	150
MSCDRI-105F-220□	22	M,N	100kHz,0.25V	59.1m	2.10	1.90	220
MSCDRI-105F-330□	33	M,N	100kHz,0.25V	81.5m	1.60	1.70	330
MSCDRI-105F-470□	47	M,N	100kHz,0.25V	0.10	1.40	1.50	470
MSCDRI-105F-680□	68	M,N	100kHz,0.25V	0.14	1.20	1.30	680
MSCDRI-105F-101□	100	M,N	100kHz,0.25V	0.20	1.00	1.10	101
MSCDRI-105F-151□	150	M,N	100kHz,0.25V	0.35	0.79	0.81	151
MSCDRI-105F-221□	220	M,N	100kHz,0.25V	0.47	0.65	0.70	221
MSCDRI-105F-331□	330	M,N	100kHz,0.25V	0.68	0.54	0.58	331
MSCDRI-105F-471□	470	M,N	100kHz,0.25V	1.03	0.47	0.47	471
MSCDRI-105F-681□	680	M,N	100kHz,0.25V	1.60	0.38	0.38	681
MSCDRI-105F-102□	1000	M,N	100kHz,0.25V	2.80	0.32	0.29	102
MSCDRI-105F-152	1500	M,N	100kHz,0.25V	3.40	0.22	0.26	152

※ ☐ specify the inductance tolerance,M(±20%),N(±30%)

% IDC1: Based on inductance change (\triangle L/Lo: \le -10%)

IDC2: Based on temperature rise ($\triangle T: 40^{\circ}C$ TYP.)

Rated DC Current: The less value which is IDC1 or IDC2.



(4) RELIABILITY TEST METHOD

MECHANICAL

TEST ITEM	SPECIFICATION	TEST DETAILS			
Substrate bending	∆L/Lo≦±5%	The sample shall be soldered onto the printed circuit board			
		in figure 1 and a load applied unitil the figure in the arrow			
	There shall be	direction is made approximately 3mm.(keep time 30 seconds)			
	no mechanical	PCB dimension shall the page 7/9			
	damage or elec-	F(Pressurization)			
	trical damege.	Ţ			
		R5 45±2 45±2 10 20 R340			
		PRESSURE ROD figure-1			
Vibration	∆L/Lo≦±5%	The sample shall be soldered onto the printed circuit board			
		and when a vibration having an amplitude of 1.52mm			
	There shall be	and a frequency of from 10 to 55Hz/1 minute repeated should			
	no mechanical	be applied to the 3 directions (X,Y,Z) for 2 hours each.			
	damage.	(A total of 6 hours)			
Solderability	New solder	Flux (rosin, isopropyl alcohol{JIS-K-1522}) shall be coated			
	More than 90%	over the whole of the sample before hard, the sample shall			
		then be preheated for about 2 minutes in a temperature of			
		130∼150℃ and after it has been immersed to a depth 0.5mm			
		below for 3±0.2 seconds fully in molten solder M705 with			
		a temperature of 245±2℃.			
		More than 90% of the electrode sections shall be couered			
		with new solder smoothly when the sample is taken out of			
		the solder bath.			



MECHANICAL

TEST ITEM	SPECIFICATION					
Resistance to Soldering heat (reflow soldering)	There shall be no damage or problems.	Temperature profile of reflow soldering soldering (Peak temperature 260±3°C 10 sec 150 Pre-heating 150 - 180°C Slow cooling (Stored at room temperature) The specimen shall be passed through the reflow oven with the condition shown in the above profile for 1 time. The specimen shall be stored at standard atmospheric conditions for 1 hour, after which the measurement shall be made.				

ELECTRICAL

TEST ITEM	SPECIFICATION	TEST DETAILS
Insulation	There shall be	DC 100V voltage shall be applied across this sample of top
resistance	no other	surface and the terminal.
	damage or	The insulation resistance shall be more than 1 × 10^8 Ω .
	problems.	
Dielectric	There shall be	AC 100V voltage shall be applied for 1 minute acrosset the top
withstand	no other	surface and the terminal of this sample
voltage	damage or	
	problems.	
Temperature	∆L/L20°C ≦±10%	The test shall be performed after the sample has stabilized in
characteristics	0~2000 ppm/℃	an ambient temperature of -20 to +85℃,and the value
		calculated based on the value applicable in a normal
		temperature and narmal humidity shall be △L/L20℃ ≦±10%.



ENVIROMENT CHARACTERISTICS

TEST ITEM				SPECIFICATION			
High temperature	∆L/Lo≦±5%	The sam	The sample shall be left for 96±4 hours in an atmospere with				
storage		a temper	a temperature of 85±2℃ and a normal humidity.				
	There shall be	Upon co	Upon completion of the measurement shall be made after the				
	no mechanical	sample h	sample has been left in a normal temperature and normal				
	damage.	humidity	humidity for 1 hour.				
l ow tomporature	∧ I /I o ✓ ±50/	The same	nlo cl	and he left for 06±4 hou	rs in an atmosphere w	vi4h	
Low temperature	∆L/Lo≦±5%		The sample shall be left for 96±4 hours in an atmosphere with				
storage	7 1 1 . 11	-	a temperature of -25±3℃.				
	There shall be	-		ion of the test, the mea			
	no mechanical		after the sample has been left in a normal temperature and				
	damage.		normal humidity for 1 hour.				
Change of	∆L/Lo≦±5%		The sample shall be subject to 5 continuos cycles, such as shown				
temperature			in the table 2 below and then it shall be subjected to standard				
	There shall be	stmosph	eric c	conditions for 1 hour, at	ter which measureme	nt	
	no other dama-	shall be i	shall be made.				
	ge of problems						
			table 2				
				Temperature	Duration		
			1	−25±3 °C	30 min.		
				(Themostat No.1)			
			2	Standard	5 sec. or less		
				atmospheric	No.1→No.2		
			3	85±2℃	30 min.		
			•	(Themostat No.2)			
			4	Standard	5 sec. or less		
			•	atmospheric	No.2→No.1		
Moisuture storage	∆L/Lo≦±5%	The sam	ple sh	nall be left for 96±4 hou	rs in a temperature of		
		40±2℃ a	nd a	humidity(RH) of 90 \sim 95	%.		
	There shall be	Upon completion of the test, the measurement shall be made					
	no mechanical	after the sample has been left in a normal temperature and					
	damage.	normal h	normal humidity more than 1 hour.				
Test conditions :	•	'					
The s	sample shall be reflo	w soldered	onto	the printed circuit boar	d in every test.		

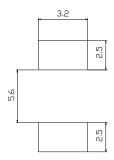


(5) LAND DIMENSION (Ref.)

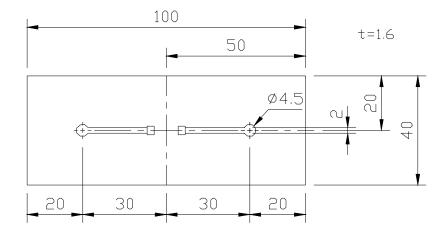
PCB: GLASS EPOXY t=1.6mm

(5)-1 LAND PATTERN DIMENSIONS

(STANDARD PATTERN)



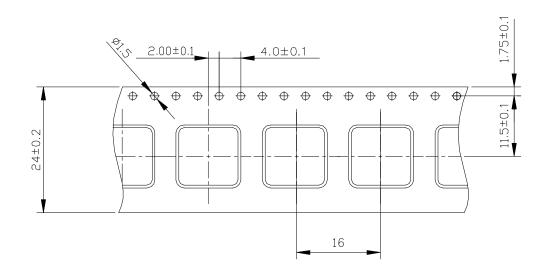
(5)-2 SUBSTRATE BENDING TEST BENDING TEST BOARD





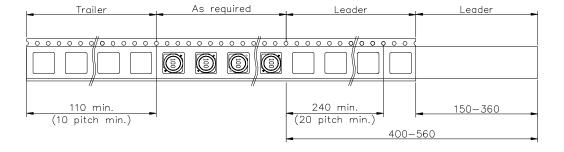
(6) PACKAGING

(6)-1 CARRIER TAPE DIMENSIONS (mm)

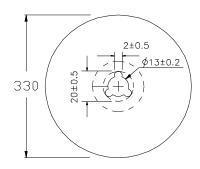


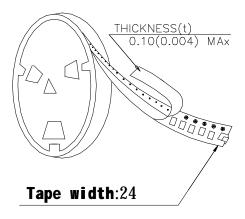
(6)-2 TAPING DIMENSIONS (mm)





(6)-3 REEL DIMENSIONS (mm)





(6)-4 QUANTITY

500pcs/Reel

The products are packaged so that no damage will be sustained.

